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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Last Time Buy
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	I ² C, LINbus, SIO, SSU, UART/USART, USB
Peripherals	POR, PWM, Voltage Detect, WDT
Number of I/O	36
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	10K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f2134ckdfp-v0

2.1 Data Registers (R0, R1, R2, and R3)

R0 is a 16-bit register for transfer, arithmetic, and logic operations. The same applies to R1 to R3. R0 can be split into high-order bits (R0H) and low-order bits (R0L) to be used separately as 8-bit data registers. R1H and R1L are analogous to R0H and R0L. R2 can be combined with R0 and used as a 32-bit data register (R2R0). R3R1 is analogous to R2R0.

2.2 Address Registers (A0 and A1)

A0 is a 16-bit register for address register indirect addressing and address register relative addressing. It is also used for transfer, arithmetic, and logic operations. A1 is analogous to A0. A1 can be combined with A0 and as a 32-bit address register (A1A0).

2.3 Frame Base Register (FB)

FB is a 16-bit register for FB relative addressing.

2.4 Interrupt Table Register (INTB)

INTB is a 20-bit register that indicates the starting address of an interrupt vector table.

2.5 Program Counter (PC)

PC is 20 bits wide and indicates the address of the next instruction to be executed.

2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

The stack pointers (SP), USP and ISP, are each 16 bits wide. The U flag of FLG is used to switch between USP and ISP.

2.7 Static Base Register (SB)

SB is a 16-bit register for SB relative addressing.

2.8 Flag Register (FLG)

FLG is an 11-bit register indicating the CPU state.

2.8.1 Carry Flag (C)

The C flag retains carry, borrow, or shift-out bits that have been generated by the arithmetic and logic unit.

2.8.2 Debug Flag (D)

The D flag is for debugging only. Set it to 0.

2.8.3 Zero Flag (Z)

The Z flag is set to 1 when an arithmetic operation results in 0; otherwise to 0.

2.8.4 Sign Flag (S)

The S flag is set to 1 when an arithmetic operation results in a negative value; otherwise to 0.

2.8.5 Register Bank Select Flag (B)

Register bank 0 is selected when the B flag is 0. Register bank 1 is selected when this flag is set to 1.

2.8.6 Overflow Flag (O)

The O flag is set to 1 when an operation results in an overflow; otherwise to 0.

4. Special Function Registers (SFRs)

An SFR (special function register) is a control register for a peripheral function. Tables 4.1 to 4.15 list the special function registers. Table 4.16 lists the ID Code Areas and Option Function Select Area.

Table 4.1 SFR Information (1) ⁽¹⁾

Address	Register	Symbol	After Reset
0000h			
0001h			
0002h			
0003h			
0004h	Processor Mode Register 0	PM0	00h
0005h	Processor Mode Register 1	PM1	00h
0006h	System Clock Control Register 0	CM0	00101000b
0007h	System Clock Control Register 1	CM1	00100000b
0008h	Module Standby Control Register	MSTCR	00h
0009h	System Clock Control Register 3	CM3	00h
000Ah	Protect Register	PRCR	00h
000Bh	Reset Source Determination Register	RSTFR	0XXXXXXb ⁽²⁾
000Ch	Oscillation Stop Detection Register	OCD	00000100b
000Dh	Watchdog Timer Reset Register	WDTR	XXh
000Eh	Watchdog Timer Start Register	WDTs	XXh
000Fh	Watchdog Timer Control Register	WDTC	00111111b
0010h			
0011h			
0012h			
0013h			
0014h			
0015h	High-Speed On-Chip Oscillator Control Register 7	FRA7	When shipping
0016h			
0017h			
0018h			
0019h			
001Ah			
001Bh			
001Ch	Count Source Protection Mode Register	CSPR	00h 10000000b ⁽³⁾
001Dh			
001Eh			
001Fh			
0020h			
0021h			
0022h			
0023h	High-Speed On-Chip Oscillator Control Register 0	FRA0	00h
0024h	High-Speed On-Chip Oscillator Control Register 1	FRA1	When shipping
0025h	High-Speed On-Chip Oscillator Control Register 2	FRA2	00h
0026h	On-Chip Reference Voltage Control Register	OCVREFCR	00h
0027h			
0028h	Clock Prescaler Reset Flag	CPSRF	00h
0029h	High-Speed On-Chip Oscillator Control Register 4	FRA4	When shipping
002Ah	High-Speed On-Chip Oscillator Control Register 5	FRA5	When shipping
002Bh	High-Speed On-Chip Oscillator Control Register 6	FRA6	When shipping
002Ch			
002Dh			
002Eh			
002Fh	High-Speed On-Chip Oscillator Control Register 3	FRA3	When shipping
0030h	Voltage Monitor Circuit Control Register	CMPA	00h
0031h	Voltage Monitor Circuit Edge Select Register	VCAC	00h
0032h			
0033h	Voltage Detect Register 1	VCA1	00001000b
0034h	Voltage Detect Register 2	VCA2	00h ⁽⁴⁾ 00100000b ⁽⁵⁾
0035h			
0036h	Voltage Detection 1 Level Select Register	VD1LS	00000111b
0037h			
0038h	Voltage Monitor 0 Circuit Control Register	VW0C	1100X010b ⁽⁴⁾ 1100X011b ⁽⁵⁾
0039h	Voltage Monitor 1 Circuit Control Register	VW1C	10001010b

X: Undefined

Notes:

1. The blank areas are reserved and cannot be accessed by users.
2. The CWR bit in the RSTFR register is set to 0 after power-on and voltage monitor 0 reset. Hardware reset, software reset, or watchdog timer reset does not affect this bit.
3. The CSPROINI bit in the OFS register is set to 0.
4. The LVDAS bit in the OFS register is set to 1.
5. The LVDAS bit in the OFS register is set to 0.

Table 4.4 SFR Information (4) ⁽¹⁾

Address	Register	Symbol	After Reset
00C0h	A/D Register 0	AD0	XXh
00C1h			000000XXb
00C2h	A/D Register 1	AD1	XXh
00C3h			000000XXb
00C4h	A/D Register 2	AD2	XXh
00C5h			000000XXb
00C6h	A/D Register 3	AD3	XXh
00C7h			000000XXb
00C8h	A/D Register 4	AD4	XXh
00C9h			000000XXb
00CAh	A/D Register 5	AD5	XXh
00CBh			000000XXb
00CCh	A/D Register 6	AD6	XXh
00CDh			000000XXb
00CEh	A/D Register 7	AD7	XXh
00CFh			000000XXb
00D0h			
00D1h			
00D2h			
00D3h			
00D4h	A/D Mode Register	ADMOD	00h
00D5h	A/D Input Select Register	ADINSEL	11000000b
00D6h	A/D Control Register 0	ADCON0	00h
00D7h	A/D Control Register 1	ADCON1	00h
00D8h			
00D9h			
00DAh			
00DBh			
00DCh			
00DDh			
00DEh			
00DFh			
00E0h	Port P0 Register	P0	XXh
00E1h	Port P1 Register	P1	XXh
00E2h	Port P0 Direction Register	PD0	00h
00E3h	Port P1 Direction Register	PD1	00h
00E4h			
00E5h	Port P3 Register	P3	XXh
00E6h			
00E7h	Port P3 Direction Register	PD3	00h
00E8h	Port P4 Register	P4	XXh
00E9h			
00EAh	Port P4 Direction Register	PD4	00h
00EBh			
00ECh	Port P6 Register	P6	XXh
00EDh	Port P7 Register	P7	XXh
00EEh	Port P6 Direction Register	PD6	00h
00EFh	Port P7 Direction Register	PD7	00h
00F0h	Port P8 Register	P8	XXh
00F1h			
00F2h	Port P8 Direction Register	PD8	00h
00F3h			
00F4h			
00F5h			
00F6h			
00F7h			
00F8h			
00F9h			
00FAh			
00FBh			
00FCh			
00FDh			
00FEh			
00FFh			

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.12 SFR Information (12) (1)

Address	Register	Symbol	After Reset
2CF0h	DTC Control Data 22	DTCD22	XXh
2CF1h			XXh
2CF2h			XXh
2CF3h			XXh
2CF4h			XXh
2CF5h			XXh
2CF6h			XXh
2CF7h			XXh
2CF8h	DTC Control Data 23	DTCD23	XXh
2CF9h			XXh
2CFAh			XXh
2CFBh			XXh
2CFCh			XXh
2CFDh			XXh
2CFEh			XXh
2CFFh			XXh
2D00h			
...			
2DFFh			
2E00h	System Configuration Control Register	SYSCFG	00h
2E01h			00h
2E02h			
2E03h			
2E04h	System Configuration Status Register 0	SYSSTS0	00000X00b
2E05h			XX000000b
2E06h			
2E07h			
2E08h	Device State Control Register 0	DVSTCTR0	00h
2E09h			00h
2E0Ah			
2E0Bh			
2E0Ch			
2E0Dh			
2E0Eh			
2E0Fh			
2E10h			
2E11h			
2E12h			
2E13h			
2E14h	CFIFO Port Register	CFIFO	00h
2E15h			00h
2E16h			
2E17h			
2E18h			
2E19h			
2E1Ah			
2E1Bh			
2E1Ch			
2E1Dh			
2E1Eh			
2E1Fh			
2E20h	CFIFO Port Select Register	CFIFOSEL	00h
2E21h	CFIFO Port Control Register	CFIFOCTR	00h
2E22h			00h
2E23h			00h
2E24h			
2E25h			
2E26h			
2E27h			
2E28h			
2E29h			
2E2Ah			
2E2Bh			
2E2Ch			
2E2Dh			
2E2Eh			
2E2Fh			

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.15 SFR Information (15) ⁽¹⁾

Address	Register	Symbol	After Reset
2F00h	USB Module Control Register	USBMC	00X10000b
2F01h	PLL Control Register 0	PLC0	0010X000b
2F02h	PLL Control Register 1	PLC1	00001100b
2F03h	PLL Division Control Register	PLDIV	00001011b
2F04h			
2F05h			
2F06h			
2F07h			
2F08h			
2F09h			
2F0Ah			
2F0Bh			
2F0Ch			
2F0Dh			
2F0Eh			
2F0Fh			
2F10h	USB Pin Select Register 0	USBSR0	00h
2F11h	USB Pin Select Register 1 ⁽²⁾	USBSR1	00h
2F12h	UART3 Pin Select Register	U3SR	00h
2F13h			
2F14h			
2F15h			
2F16h			
2F17h			
2F18h			
2F19h			
2F1Ah			
2F1Bh			
2F1Ch			
2F1Dh			
2F1Eh			
2F1Fh			
:			
2FFFh			

X: Undefined

Notes:

1. The blank areas are reserved and cannot be accessed by users.
2. This register is not available in the R8C/34U Group.

Table 4.16 ID Code Areas and Option Function Select Area

Address	Area Name	Symbol	After Reset
:			
FFDBh	Option Function Select Register 2	OFS2	(Note 1)
:			
FFDFh	ID1		(Note 2)
:			
FFE3h	ID2		(Note 2)
:			
FFEBh	ID3		(Note 2)
:			
FFEFh	ID4		(Note 2)
:			
FFF3h	ID5		(Note 2)
:			
FFF7h	ID6		(Note 2)
:			
FFFBh	ID7		(Note 2)
:			
FFFFh	Option Function Select Register	OFS	(Note 1)

Notes:

1. The option function select area is allocated in the flash memory, not in the SFRs. Set appropriate values as ROM data by a program. Do not write additions to the option function select area. If the block including the option function select area is erased, the option function select area is set to FFh. When blank products are shipped, the option function select area is set to FFh. It is set to the written value after written by the user. When factory-programming products are shipped, the value of the option function select area is the value programmed by the user.
2. The ID code areas are allocated in the flash memory, not in the SFRs. Set appropriate values as ROM data by a program. Do not write additions to the ID code areas. If the block including the ID code areas is erased, the ID code areas are set to FFh. When blank products are shipped, the ID code areas are set to FFh. They are set to the written value after written by the user. When factory-programming products are shipped, the value of the ID code areas is the value programmed by the user.

5. Electrical Characteristics

5.1 R8C/34U Group

Table 5.1 Absolute Maximum Ratings

Symbol	Parameter	Condition	Rated Value	Unit
V _{CC} /A _V CC	Supply voltage		−0.3 to 6.5	V
V _I	Input voltage		−0.3 to V _{CC} + 0.3	V
V _O	Output voltage		−0.3 to V _{CC} + 0.3	V
P _d	Power dissipation	−40°C ≤ T _{opr} ≤ 85°C	500	mW
T _{opr}	Operating ambient temperature		−20 to 85 (N version)/ −40 to 85 (D version)	°C
T _{stg}	Storage temperature		−65 to 150	°C

Table 5.2 Recommended Operating Conditions (1)

Symbol	Parameter				Conditions	Standard			Unit	
						Min.	Typ.	Max.		
Vcc/AVcc	Supply voltage	When USB function is used					3.0	5.0	5.5	V
		When USB function is not used					1.8	5.0	5.5	V
UVcc	USB Supply Voltage (When UVCC pin is input)	When USB function is used				Vcc/AVcc = 3.0 to 3.6 V	—	Vcc/AVcc (4)	—	V
		When USB function is not used				Vcc/AVcc = 1.8 to 5.5 V	—	Vcc/AVcc (4)	—	V
Vss/AVss	Supply voltage						—	0	—	V
ViH	Input “H” voltage	Other than CMOS input					0.8 Vcc	—	Vcc	V
		CMOS input	Input level switching function (I/O port)	Input level selection: 0.35 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0.5 Vcc	—	Vcc	V	
					2.7 V ≤ Vcc < 4.0 V	0.55 Vcc	—	Vcc	V	
					1.8 V ≤ Vcc < 2.7 V	0.65 Vcc	—	Vcc	V	
				Input level selection: 0.5 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0.65 Vcc	—	Vcc	V	
					2.7 V ≤ Vcc < 4.0 V	0.7 Vcc	—	Vcc	V	
					1.8 V ≤ Vcc < 2.7 V	0.8 Vcc	—	Vcc	V	
				Input level selection: 0.7 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0.85 Vcc	—	Vcc	V	
					2.7 V ≤ Vcc < 4.0 V	0.85 Vcc	—	Vcc	V	
					1.8 V ≤ Vcc < 2.7 V	0.85 Vcc	—	Vcc	V	
		External clock input (XOUT)					1.2	—	Vcc	V
ViL	Input “L” voltage	Other than CMOS input					0	—	0.2 Vcc	V
		CMOS input	Input level switching function (I/O port)	Input level selection: 0.35 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0	—	0.2 Vcc	V	
					2.7 V ≤ Vcc < 4.0 V	0	—	0.2 Vcc	V	
					1.8 V ≤ Vcc < 2.7 V	0	—	0.2 Vcc	V	
				Input level selection: 0.5 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0	—	0.4 Vcc	V	
					2.7 V ≤ Vcc < 4.0 V	0	—	0.3 Vcc	V	
					1.8 V ≤ Vcc < 2.7 V	0	—	0.2 Vcc	V	
				Input level selection: 0.7 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0	—	0.55 Vcc	V	
					2.7 V ≤ Vcc < 4.0 V	0	—	0.45 Vcc	V	
					1.8 V ≤ Vcc < 2.7 V	0	—	0.35 Vcc	V	
		External clock input (XOUT)					0	—	0.4	V
IOH(sum)	Peak sum output “H” current	Sum of all pins IOH(peak)					—	—	−160	mA
IOH(sum)	Average sum output “H” current	Sum of all pins IOH(avg)					—	—	−80	mA
IOH(peak)	Peak output “H” current	Drive capacity Low					—	—	−10	mA
		Drive capacity High					—	—	−40	mA
IOH(avg)	Average output “H” current	Drive capacity Low					—	—	−5	mA
		Drive capacity High					—	—	−20	mA
IoL(sum)	Peak sum output “L” current	Sum of all pins IoL(peak)					—	—	160	mA
IoL(sum)	Average sum output “L” current	Sum of all pins IoL(avg)					—	—	80	mA
IoL(peak)	Peak output “L” current	Drive capacity Low					—	—	10	mA
		Drive capacity High					—	—	40	mA
IoL(avg)	Average output “L” current	Drive capacity Low					—	—	5	mA
		Drive capacity High					—	—	20	mA
f(XIN)	XIN clock input oscillation frequency					2.7 V ≤ Vcc ≤ 5.5 V	—	—	20	MHz
						1.8 V ≤ Vcc < 2.7 V	—	—	5	MHz
fOCO40M	When used as the count source for timer RC (3)					2.7 V ≤ Vcc ≤ 5.5 V	32	—	40	MHz
fOCO-F	fOCO-F frequency					2.7 V ≤ Vcc ≤ 5.5 V	—	—	20	MHz
						1.8 V ≤ Vcc < 2.7 V	—	—	5	MHz
—	System clock frequency					2.7 V ≤ Vcc ≤ 5.5 V	—	—	20	MHz
						1.8 V ≤ Vcc < 2.7 V	—	—	5	MHz
f(BCLK)	CPU clock frequency					2.7 V ≤ Vcc ≤ 5.5 V	—	—	20	MHz
						1.8 V ≤ Vcc < 2.7 V	—	—	5	MHz
tsu(PLL)	PLL frequency synthesizer stabilization wait time					4.0 V ≤ Vcc ≤ 5.5 V	—	—	2	ms
						2.7 V ≤ Vcc < 4.0 V	—	—	3	ms

Notes:

1. V_{CC} = 1.8 to 5.5 V and T_{opr} = −20 to 85 °C (N version)/−40 to 85 °C (D version), unless otherwise specified.
2. The average output current indicates the average value of current measured during 100 ms.
3. f_{OCO40M} can be used as the count source for timer RC in the range of V_{CC} = 2.7 to 5.5 V.
4. Connect V_{CC}/AV_{CC} for the UV_{CC} pin input.

Table 5.4 Comparator B Electrical Characteristics

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
V _{ref}	IVREF1, IVREF3 input reference voltage		0	—	V _{CC} – 1.4	V
V _I	IVCMP1, IVCMP3 input voltage		–0.3	—	V _{CC} + 0.3	V
—	Offset		—	5	100	mV
t _d	Comparator output delay time ⁽²⁾	V _I = V _{ref} ± 100 mV	—	0.1	—	μs
I _{CMP}	Comparator operating current	V _{CC} = 5.0 V	—	17.5	—	μA

Notes:

1. V_{CC} = 2.7 to 5.5 V and T_{opr} = –20 to 85 °C (N version)/–40 to 85 °C (D version), unless otherwise specified.
2. When the digital filter is disabled.

Table 5.8 Voltage Detection 0 Circuit Electrical Characteristics

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
Vdet0	Voltage detection level Vdet0_0 ⁽²⁾		1.80	1.90	2.05	V
	Voltage detection level Vdet0_1 ⁽²⁾		2.15	2.35	2.50	V
	Voltage detection level Vdet0_2 ⁽²⁾		2.70	2.85	3.05	V
	Voltage detection level Vdet0_3 ⁽²⁾		3.55	3.80	4.05	V
—	Voltage detection 0 circuit response time ⁽⁴⁾	At the falling of Vcc from 5.0 V to (Vdet0_0 – 0.1) V	—	6	150	μs
—	Voltage detection circuit self power consumption	VCA25 = 1, Vcc = 5.0 V	—	1.5	—	μA
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽³⁾		—	—	100	μs

Notes:

1. The measurement condition is Vcc = 1.8 to 5.5 V and T_{opr} = –20 to 85 °C (N version)/–40 to 85 °C (D version).
2. Select the voltage detection level with bits VDSEL0 and VDSEL1 in the OFS register.
3. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA25 bit in the VCA2 register to 0.
4. Time until the voltage monitor 0 reset is generated after the voltage passes Vdet0.

Table 5.9 Voltage Detection 1 Circuit Electrical Characteristics

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
Vdet1	Voltage detection level Vdet1_0 ⁽²⁾	At the falling of Vcc	2.00	2.20	2.40	V
	Voltage detection level Vdet1_1 ⁽²⁾	At the falling of Vcc	2.15	2.35	2.55	V
	Voltage detection level Vdet1_2 ⁽²⁾	At the falling of Vcc	2.30	2.50	2.70	V
	Voltage detection level Vdet1_3 ⁽²⁾	At the falling of Vcc	2.45	2.65	2.85	V
	Voltage detection level Vdet1_4 ⁽²⁾	At the falling of Vcc	2.60	2.80	3.00	V
	Voltage detection level Vdet1_5 ⁽²⁾	At the falling of Vcc	2.75	2.95	3.15	V
	Voltage detection level Vdet1_6 ⁽²⁾	At the falling of Vcc	2.85	3.10	3.40	V
	Voltage detection level Vdet1_7 ⁽²⁾	At the falling of Vcc	3.00	3.25	3.55	V
	Voltage detection level Vdet1_8 ⁽²⁾	At the falling of Vcc	3.15	3.40	3.70	V
	Voltage detection level Vdet1_9 ⁽²⁾	At the falling of Vcc	3.30	3.55	3.85	V
	Voltage detection level Vdet1_A ⁽²⁾	At the falling of Vcc	3.45	3.70	4.00	V
	Voltage detection level Vdet1_B ⁽²⁾	At the falling of Vcc	3.60	3.85	4.15	V
	Voltage detection level Vdet1_C ⁽²⁾	At the falling of Vcc	3.75	4.00	4.30	V
	Voltage detection level Vdet1_D ⁽²⁾	At the falling of Vcc	3.90	4.15	4.45	V
	Voltage detection level Vdet1_E ⁽²⁾	At the falling of Vcc	4.05	4.30	4.60	V
	Voltage detection level Vdet1_F ⁽²⁾	At the falling of Vcc	4.20	4.45	4.75	V
—	Hysteresis width at the rising of Vcc in voltage detection 1 circuit	Vdet1_0 to Vdet1_5 selected	—	0.07	—	V
		Vdet1_6 to Vdet1_F selected	—	0.10	—	V
—	Voltage detection 1 circuit response time ⁽³⁾	At the falling of Vcc from 5.0 V to (Vdet1_0 – 0.1) V	—	60	150	μs
—	Voltage detection circuit self power consumption	VCA26 = 1, Vcc = 5.0 V	—	1.7	—	μA
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽⁴⁾		—	—	100	μs

Notes:

1. The measurement condition is Vcc = 1.8 to 5.5 V and T_{opr} = –20 to 85 °C (N version)/–40 to 85 °C (D version).
2. Select the voltage detection level with bits VD1S0 to VD1S3 in the VD1LS register.
3. Time until the voltage monitor 1 interrupt request is generated after the voltage passes Vdet1.
4. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0.

Table 5.10 Voltage Detection 2 Circuit Electrical Characteristics

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
Vdet2	Voltage detection level Vdet2_0	At the falling of Vcc	3.70	4.00	4.30	V
—	Hysteresis width at the rising of Vcc in voltage detection 2 circuit		—	0.10	—	V
—	Voltage detection 2 circuit response time (2)	At the falling of Vcc from 5.0 V to (Vdet2_0 – 0.1) V	—	20	150	μs
—	Voltage detection circuit self power consumption	VCA27 = 1, Vcc = 5.0 V	—	1.7	—	μA
td(E-A)	Waiting time until voltage detection circuit operation starts (3)		—	—	100	μs

Notes:

1. The measurement condition is Vcc = 1.8 to 5.5 V and T_{opr} = –20 to 85 °C (N version)/–40 to 85 °C (D version).
2. Time until the voltage monitor 2 interrupt request is generated after the voltage passes Vdet2.
3. Necessary time until the voltage detection circuit operates after setting to 1 again after setting the VCA27 bit in the VCA2 register to 0.

Table 5.11 Power-on Reset Circuit (2)

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
trth	External power Vcc rise gradient	(1)	0	—	50,000	mV/msec

Notes:

1. The measurement condition is T_{opr} = –20 to 85 °C (N version)/–40 to 85 °C (D version), unless otherwise specified.
2. To use the power-on reset function, enable voltage monitor 0 reset by setting the LVDAS bit in the OFS register to 0.

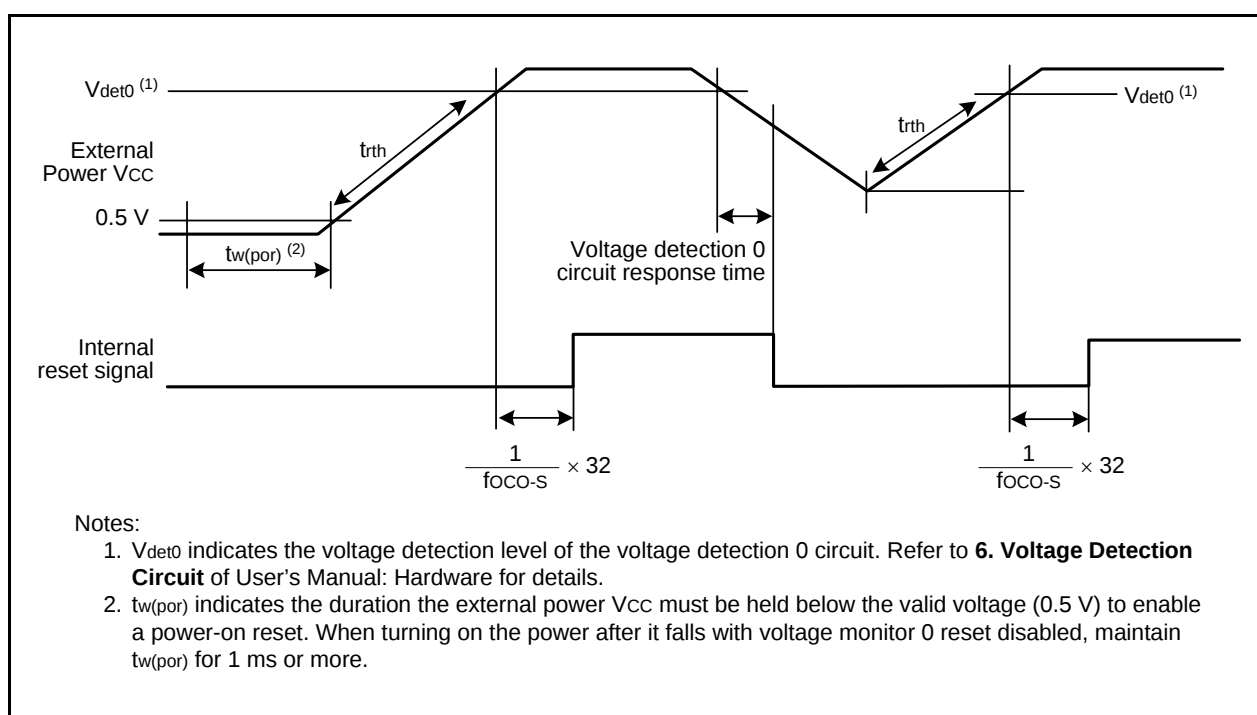
**Figure 5.5 Power-on Reset Circuit Electrical Characteristics**

Table 5.18 Electrical Characteristics (2) [$3.3\text{ V} \leq V_{CC} \leq 5.5\text{ V}$]
($T_{opr} = -20\text{ to }85\text{ }^{\circ}\text{C}$ (N version)/ $-40\text{ to }85\text{ }^{\circ}\text{C}$ (D version), unless otherwise specified.)

Symbol	Parameter	Condition	Standard			Unit	
			Min.	Typ.	Max.		
Icc	Power supply current (Vcc = 3.3 to 5.5 V) Single-chip mode, output pins are open, other pins are Vss	High-speed clock mode	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	—	6.5	15	mA
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	—	5.3	12.5	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	—	3.6	—	mA
			XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	—	3.0	—	mA
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	—	2.2	—	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	—	1.5	—	mA
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz No division	—	7.0	15	mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	—	3.0	—	mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 4 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-16, MSTIIC = MSTTRC = 1	—	1	—	mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR27 = 1, VCA20 = 0	—	90	400	μA
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	—	15	100	μA
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	—	4	90	μA
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	—	3.5	—	μA
		Stop mode	XIN clock off, Topr = 25 °C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	—	2.0	5.0	μA
			XIN clock off, Topr = 85 °C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	—	15	—	μA

Table 5.31 Electrical Characteristics (5) [$1.8\text{ V} \leq V_{CC} < 2.7\text{ V}$]

Symbol	Parameter		Condition		Standard			Unit
					Min.	Typ.	Max.	
V _{OH}	Output "H" voltage	Other than XOUT	Drive capacity High	I _{OH} = -2 mA	V _{CC} - 0.5	—	V _{CC}	V
			Drive capacity Low	I _{OH} = -1 mA	V _{CC} - 0.5	—	V _{CC}	V
		XOUT		I _{OH} = -200 μ A	1.0	—	V _{CC}	V
V _{OL}	Output "L" voltage	Other than XOUT	Drive capacity High	I _{OL} = 2 mA	—	—	0.5	V
			Drive capacity Low	I _{OL} = 1 mA	—	—	0.5	V
		XOUT		I _{OL} = 200 μ A	—	—	0.5	V
V _{T+} -V _{T-}	Hysteresis	$\overline{\text{NT0}}$, $\overline{\text{INT1}}$, $\overline{\text{INT2}}$, $\overline{\text{INT3}}$, $\overline{\text{INT4}}$, $\overline{\text{KI0}}$, $\overline{\text{KI1}}$, $\overline{\text{KI2}}$, $\overline{\text{KI3}}$, $\overline{\text{TRAIO}}$, $\overline{\text{TRCIOA}}$, $\overline{\text{TRCIOB}}$, $\overline{\text{TRCIOC}}$, $\overline{\text{TRCIOD}}$, $\overline{\text{TRFI}}$, $\overline{\text{TRCTRG}}$, $\overline{\text{TRCCLK}}$, $\overline{\text{ADTRG}}$, $\overline{\text{RXD0}}$, $\overline{\text{RXD1}}$, $\overline{\text{RXD2}}$, $\overline{\text{RXD3}}$, $\overline{\text{CLK0}}$, $\overline{\text{CLK1}}$, $\overline{\text{CLK2}}$, $\overline{\text{CLK3}}$, $\overline{\text{CTS2}}$, $\overline{\text{SSI}}$, $\overline{\text{SCL}}$, $\overline{\text{SDA}}$, $\overline{\text{SSO}}$, $\overline{\text{SSCK}}$, $\overline{\text{SCS}}$			0.05	0.20	—	V
		$\overline{\text{RESET}}$			0.05	0.20	—	V
I _{IH}	Input "H" current		V _I = 2.2 V, V _{CC} = 2.2 V		—	—	4.0	μ A
I _{IL}	Input "L" current		V _I = 0 V, V _{CC} = 2.2 V		—	—	-4.0	μ A
R _{PULLUP}	Pull-up resistance		V _I = 0 V, V _{CC} = 2.2 V		70	140	300	k Ω
R _{IXIN}	Feedback resistance	XIN			—	0.3	—	M Ω
V _{RAM}	RAM hold voltage		During stop mode		1.8	—	—	V

Note:

1. $1.8\text{ V} \leq V_{CC} < 2.7\text{ V}$, T_{opr} = -20 to 85 °C (N version)/-40 to 85 °C (D version), and f(XIN) = 5 MHz, unless otherwise specified.

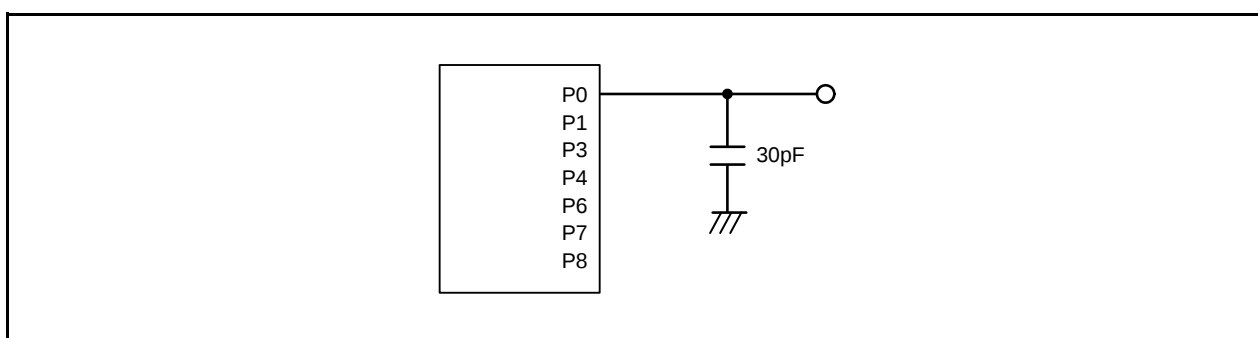


Figure 5.25 Ports P0, P1, P3, P4, P6, P7 and P8 Timing Measurement Circuit

Table 5.40 A/D Converter Characteristics

Symbol	Parameter		Conditions		Standard			Unit
					Min.	Typ.	Max.	
—	Resolution		V _{ref} = AV _{CC}		—	—	10	Bit
—	Absolute accuracy	10-bit mode	V _{ref} = AV _{CC} = 5.0 V	AN0 to AN7 input, AN8 to AN11 input	—	—	±3	LSB
			V _{ref} = AV _{CC} = 3.3 V	AN0 to AN7 input, AN8 to AN11 input	—	—	±5	LSB
			V _{ref} = AV _{CC} = 3.0 V	AN0 to AN7 input, AN8 to AN11 input	—	—	±5	LSB
			V _{ref} = AV _{CC} = 2.2 V	AN0 to AN7 input, AN8 to AN11 input	—	—	±5	LSB
		8-bit mode	V _{ref} = AV _{CC} = 5.0 V	AN0 to AN7 input, AN8 to AN11 input	—	—	±2	LSB
			V _{ref} = AV _{CC} = 3.3 V	AN0 to AN7 input, AN8 to AN11 input	—	—	±2	LSB
			V _{ref} = AV _{CC} = 3.0 V	AN0 to AN7 input, AN8 to AN11 input	—	—	±2	LSB
			V _{ref} = AV _{CC} = 2.2 V	AN0 to AN7 input, AN8 to AN11 input	—	—	±2	LSB
φAD	A/D conversion clock		4.0 V ≤ V _{ref} = AV _{CC} ≤ 5.5 V ⁽²⁾		2	—	20	MHz
			3.2 V ≤ V _{ref} = AV _{CC} ≤ 5.5 V ⁽²⁾		2	—	16	MHz
			2.7 V ≤ V _{ref} = AV _{CC} ≤ 5.5 V ⁽²⁾		2	—	10	MHz
			2.2 V ≤ V _{ref} = AV _{CC} ≤ 5.5 V ⁽²⁾		2	—	5	MHz
—	Tolerance level impedance				—	3	—	kΩ
t _{CONV}	Conversion time	10-bit mode	V _{ref} = AV _{CC} = 5.0 V, φAD = 20 MHz		2.2	—	—	μs
		8-bit mode	V _{ref} = AV _{CC} = 5.0 V, φAD = 20 MHz		2.2	—	—	μs
t _{SAMP}	Sampling time		φAD = 20 MHz		0.8	—	—	μs
I _{Vref}	V _{ref} current		V _{CC} = 5.0 V, XIN = f1 = φAD = 20 MHz		—	45	—	μA
V _{ref}	Reference voltage				2.2	—	AV _{CC}	V
V _{IA}	Analog input voltage ⁽³⁾				0	—	V _{ref}	V
OCVREF	On-chip reference voltage		2 MHz ≤ φAD ≤ 4 MHz		1.19	1.34	1.49	V

Notes:

- $V_{cc}/AV_{cc} = V_{ref} = 2.2\text{ to }5.5\text{ V}$, $V_{ss} = 0\text{ V}$, and $T_{opr} = -20\text{ to }85\text{ }^\circ\text{C}$ (N version)/ $-40\text{ to }85\text{ }^\circ\text{C}$ (D version), unless otherwise specified.
- The A/D conversion result will be undefined in wait mode, stop mode, when the flash memory stops, and in low-current-consumption mode. Do not perform A/D conversion in these states or transition to these states during A/D conversion.
- When the analog input voltage is over the reference voltage, the A/D conversion result will be 3FFh in 10-bit mode and FFh in 8-bit mode.

Table 5.42 USB Characteristics

Symbol	Parameter		Condition	Standard			Unit
				Min.	Typ.	Max.	
V_{IH}	Input characteristics	Input "H" voltage	Figures 5.26 and 5.27	2.0	—	—	V
V_{IL}		Input "L" voltage		—	—	0.8	V
V_{DI}		Differential input sensitivity		0.2	—	—	V
V_{CM}		Differential common mode range		0.8	—	2.5	V
V_{OH}	Output characteristics	Output "H" voltage	Figures 5.26 and 5.27 $I_{CH} = 200\mu A$	2.8	—	—	V
V_{OL}		Output "L" voltage	Figures 5.26 and 5.27 $I_{CL} = 2\text{ mA}$	—	—	0.3	V
V_{CRS}		Crossover voltage	Figures 5.26 and 5.27	1.3	—	2.0	V
t_R		Rise time	Figures 5.26 and 5.27	4.0	—	20.0	ns
t_F		Fall time	Figures 5.26 and 5.27	4.0	—	20.0	ns
t_{RFM}		Rise time / Fall time matching	Figures 5.26 and 5.27 (t_R/t_F)	90.0	—	111.1	%
Z_{DRV}		Output resistance	Figures 5.26 and 5.27 Includes $R_s = 27\Omega$	28	—	44.0	Ω
UVCC	UVCC output voltage	$V_{CC} = 4.0\text{ to }5.5\text{ V}$, $PXXCON = VDDUSB_E = 1$		3.0	3.3	3.6	V
		$PXXCON = 0$		—	V_{CC}	—	V
I_{susp}	Consumption current of the Internal power supply for USB		$V_{CC} = 4.0\text{ to }5.5\text{ V}$ $UV_{CC} - V_{SS} 0.33\mu F$ $V_{CC} - V_{SS} 0.1\mu F$		50		μA

Note:

1. Referenced to $V_{CC} = 3.0\text{ to }5.5\text{ V}$, $UV_{CC} = 3.0\text{ V}$, at $T_{opr} = -20\text{ to }85\text{ }^\circ\text{C}$ (N version)/ $-40\text{ to }85\text{ }^\circ\text{C}$ (D version), unless otherwise specified.

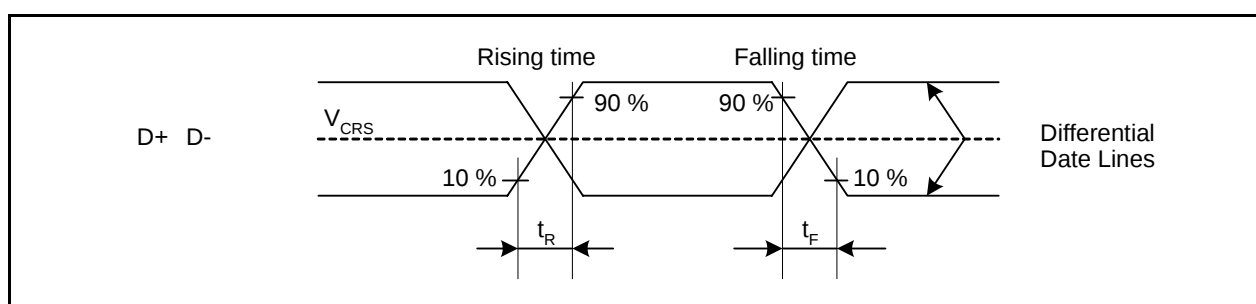
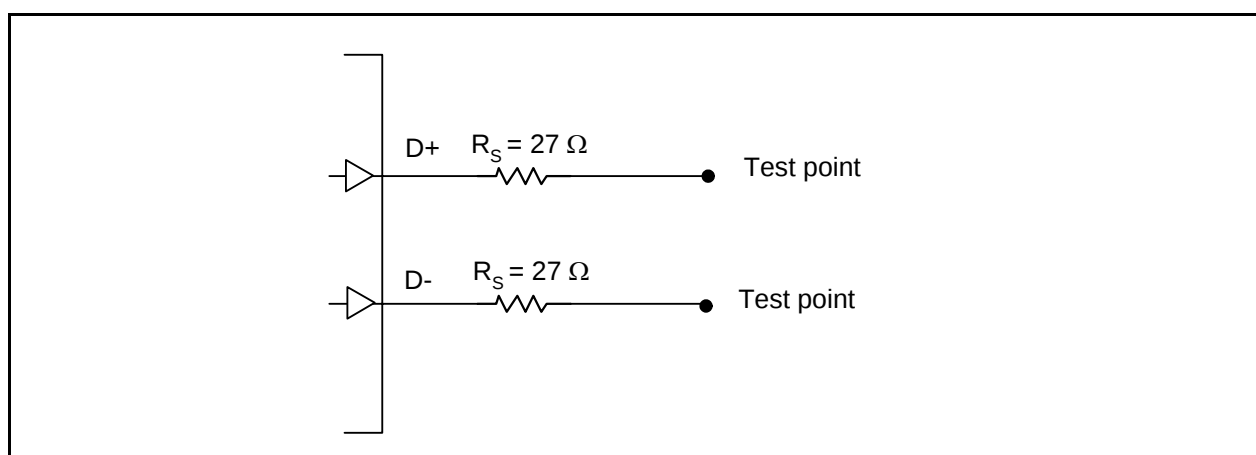
**Figure 5.26 Data Signal Timing Diagram****Figure 5.27 Load Condition**

Table 5.53 Timing Requirements of I²C bus Interface

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
t _{SCL}	SCL input cycle time		12t _{cy} + 600 ⁽²⁾	—	—	ns
t _{SCLH}	SCL input "H" width		3t _{cy} + 300 ⁽²⁾	—	—	ns
t _{SCLL}	SCL input "L" width		5t _{cy} + 500 ⁽²⁾	—	—	ns
t _{sf}	SCL, SDA input fall time		—	—	300	ns
t _{SP}	SCL, SDA input spike pulse rejection time		—	—	1t _{cy} ⁽²⁾	ns
t _{BUF}	SDA input bus-free time		5t _{cy} ⁽²⁾	—	—	ns
t _{STAH}	Start condition input hold time		3t _{cy} ⁽²⁾	—	—	ns
t _{STAS}	Retransmit start condition input setup time		3t _{cy} ⁽²⁾	—	—	ns
t _{STOP}	Stop condition input setup time		3t _{cy} ⁽²⁾	—	—	ns
t _{SDAS}	Data input setup time		1t _{cy} + 40 ⁽²⁾	—	—	ns
t _{SDAH}	Data input hold time		10	—	—	ns

Notes:

1. V_{CC} = 1.8 to 5.5 V, V_{SS} = 0 V, and T_{opr} = -20 to 85 °C (N version)/-40 to 85 °C (D version), unless otherwise specified.
2. 1t_{cy} = 1/f₁(s)

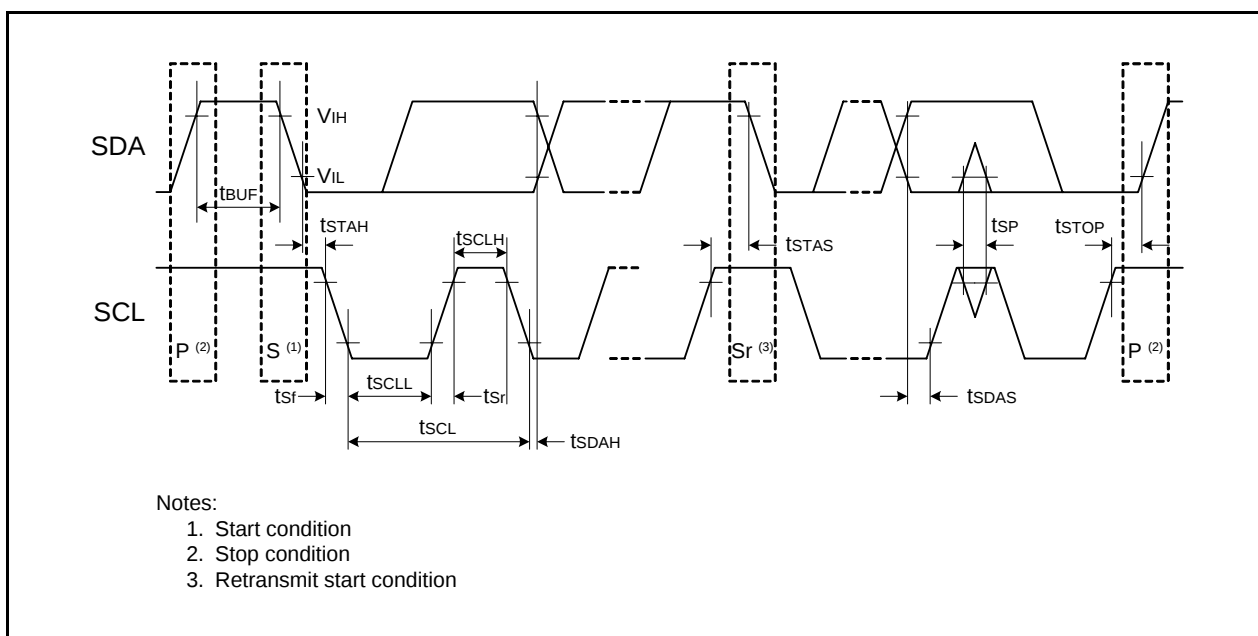
**Figure 5.33 I/O Timing of I²C bus Interface**

Table 5.61 Electrical Characteristics (3) [$2.7\text{ V} \leq V_{CC} < 4.2\text{ V}$]

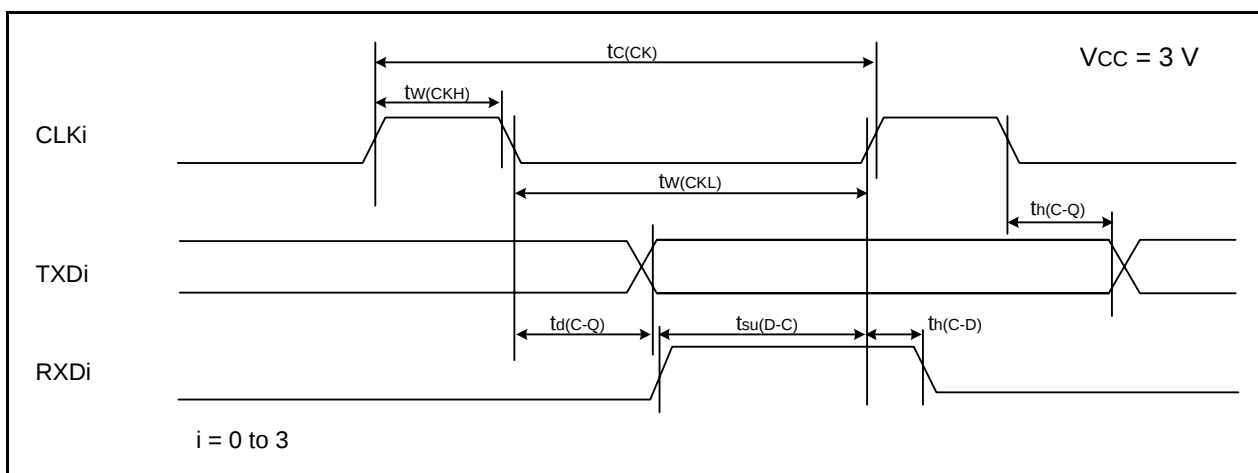
Symbol	Parameter		Condition		Standard			Unit
					Min.	Typ.	Max.	
V _{OH}	Output "H" voltage	Other than XOUT	Drive capacity High	I _{OH} = -5 mA	V _{CC} - 0.5	—	V _{CC}	V
			Drive capacity Low	I _{OH} = -1 mA	V _{CC} - 0.5	—	V _{CC}	V
		XOUT		I _{OH} = -200 μ A	1.0	—	V _{CC}	V
V _{OL}	Output "L" voltage	Other than XOUT	Drive capacity High	I _{OL} = 5 mA	—	—	0.5	V
			Drive capacity Low	I _{OL} = 1 mA	—	—	0.5	V
		XOUT		I _{OL} = 200 μ A	—	—	0.5	V
V _{T+} -V _{T-}	Hysteresis	INT0, INT1, INT2, INT3, INT4, K10, K11, K12, K13, TRAIO, TRCIOA, TRCIOB, TRCIOA, TRCIOC, TRCIOC, TRCIOC, TRFI, USB_OVRCURA, USB_VBUS, USB_ID, USB_OVRCURB, TRCTRG, TRCCLK, ADTRG, RXD0, RXD1, RXD2, RXD3, CLK0, CLK1, CLK2, CLK3, CTS2, SSI, SCL, SDA, SSO, SSCK, SCS	V _{CC} = 3.0 V		0.1	0.4	—	V
		RESET	V _{CC} = 3.0 V		0.1	0.5	—	V
I _{IH}	Input "H" current		V _I = 3 V, V _{CC} = 3.0 V		—	—	4.0	μ A
I _{IL}	Input "L" current		V _I = 0 V, V _{CC} = 3.0 V		—	—	-4.0	μ A
R _{PULLUP}	Pull-up resistance		V _I = 0 V, V _{CC} = 3.0 V		42	84	168	k Ω
R _{FXIN}	Feedback resistance	XIN			—	0.3	—	M Ω
V _{RAM}	RAM hold voltage		During stop mode		1.8	—	—	V

Note:

1. $2.7\text{ V} \leq V_{CC} < 4.2\text{ V}$, T_{opr} = -20 to 85 °C (N version)/-40 to 85 °C (D version), and f(XIN) = 10 MHz, unless otherwise specified.
2. $3.0\text{ V} \leq V_{CC} < 3.6\text{ V}$ for the USB associated pins.

Table 5.66 Serial Interface

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(CK)}$	CLKi input cycle time	300	—	ns
$t_{w(CKH)}$	CLKi input "H" width	150	—	ns
$t_{w(CKL)}$	CLKi Input "L" width	150	—	ns
$t_{d(C-Q)}$	TXDi output delay time	—	80	ns
$t_{h(C-Q)}$	TXDi hold time	0	—	ns
$t_{su(D-C)}$	RXDi input setup time	70	—	ns
$t_{h(C-D)}$	RXDi input hold time	90	—	ns

 $i = 0 \text{ to } 3$ **Figure 5.42 Serial Interface Timing Diagram when Vcc = 3 V****Table 5.67 External Interrupt $\overline{INTi}$ ($i = 0 \text{ to } 4$) Input, Key Input Interrupt $\overline{Kli}$ ($i = 0 \text{ to } 3$)**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{w(INH)}$	$\overline{INTi}$ input "H" width, $\overline{Kli}$ input "H" width	380 (1)	—	ns
$t_{w(INL)}$	$\overline{INTi}$ input "L" width, $\overline{Kli}$ input "L" width	380 (2)	—	ns

Notes:

1. When selecting the digital filter by the $\overline{INTi}$ input filter select bit, use an $\overline{INTi}$ input HIGH width of either (1/digital filter clock frequency $\times 3$) or the minimum value of standard, whichever is greater.
2. When selecting the digital filter by the $\overline{INTi}$ input filter select bit, use an $\overline{INTi}$ input LOW width of either (1/digital filter clock frequency $\times 3$) or the minimum value of standard, whichever is greater.

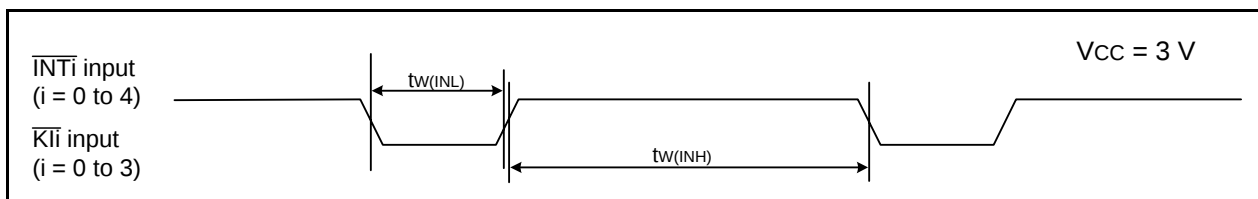
**Figure 5.43 Input Timing Diagram for External Interrupt $\overline{INTi}$ and Key Input Interrupt $\overline{Kli}$ when Vcc = 3 V**

Table 5.69 Electrical Characteristics (6) [$1.8\text{ V} \leq V_{CC} < 2.7\text{ V}$]
($T_{opr} = -20\text{ to }85\text{ }^{\circ}\text{C}$ (N version)/ $-40\text{ to }85\text{ }^{\circ}\text{C}$ (D version), unless otherwise specified.)

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
I _{CC}	Power supply current ($V_{CC} = 1.8\text{ to }2.7\text{ V}$) Single-chip mode, output pins are open, other pins are V _{SS}	High-speed clock mode	—	2.2	—	mA
				0.8	—	mA
		High-speed on-chip oscillator mode	—	2.5	10	mA
				1.7	—	mA
				1	—	mA
		Low-speed on-chip oscillator mode	—	90	300	μA
		Wait mode	—	15	90	μA
				4	80	μA
				3.5	—	μA
				2.0	5	μA
		Stop mode	—	15	—	μA
				—	—	μA

REVISION HISTORY	R8C/34U Group, R8C/34K Group Datasheet
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Rev.	Date	Description	
		Page	Summary
1.10	Jun 15, 2011	All pages	R8C/34U Group Datasheet (R01DS0039EJ0100) and R8C/34K Group Datasheet (R01DS0040EJ0100): revised and combined into one document
		2	1.1.2, Table 1.1 added
		4	Table 1.3 USB Functions: Specification revised (34U Group)
			Table 1.9 USB: Description revised (34U Group)
		18	3.1 revised
		19	3.2 revised
		32	Table 4.13 revised
		33	Table 4.14 2ED2h to 2ED7h revised (34U Group)
		36	Table 5.2 “tsu(PLL): PLL frequency synthesizer stabilization” added
		64	Table 5.39 “tsu(PLL): PLL frequency synthesizer stabilization” added

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